

In the Specification:

On page 3, replace paragraph 2 with the following paragraph 2:

FIG. 2 illustrates a 3-D multi-plane coupling structure of the prior art with the associated upper and lower coupling plates 200 and 202 with current vectors (“ $i_o$ ” and “ $i_2$ ”, respectively). ~~Note that the~~ The and coupling plates 200 and 202 have an H-field generated by RF current “ $i_i$ ” propagating along transmission line 201 that induces H-fields of like polarity on coupling plates 200 and 202 for the surface facing the transmission. In other words, the ~~H-field~~ H-field for the lower side of upper plate 200 is vectored the same as the top side of transmission line 201, and the H field for the top side of lower plate 202 is vectored the same as the lower surface of transmission line 201. These time varying magnetic fields generate current vectors  $i_o$  and  $i_2$  respectively ~~polarities that are additive to the corresponding transmission line 201~~. It is important to note that the H-field polarity of the lower surface of upper plate 200 CONFLICTS with the top surface polarity of lower plate 202. Thus, regions where the upper and lower plate overlap will cause reduced coupling efficiency, due to H-field cancellation, if they are electrically connected together (i.e.[:]) Current flows in the same direction in both structures). It is therefore imperative that the multi-layered helical geometry minimize regions of overlap between differing planes having current vectors oriented in the same direction.